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VARJOS(10) **Pub. No.: US 2022/0386474 A1**(43) **Pub. Date: Dec. 1, 2022**(54) **LAYERED DEVICE FOR PRESSURE
TREATMENT AND METHOD***B32B 27/32* (2006.01)*B32B 27/28* (2006.01)*B32B 37/10* (2006.01)*B32B 38/00* (2006.01)(71) Applicant: **Canatu Oy**, Vantaa (FI)(72) Inventor: **Ilkka VARJOS**, Espoo (FI)(73) Assignee: **Canatu Oy**, Vantaa (FI)(21) Appl. No.: **17/642,865**(22) PCT Filed: **Sep. 23, 2020**(86) PCT No.: **PCT/FI2020/050619**

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(57)

ABSTRACT

A layered device having two base films, a conductive pattern attached to the first base film facing the second base film and a bonding layer binding the first base film and the second base film together. The bonding layer includes an opening, and the conductive pattern having an exposed portion aligned with the opening in the bonding layer. Further disclosed is a spacer attached to the first base film and the exposed portion of the conductive pattern, wherein the spacer fills at least part of the space created by the opening in the bonding layer. Also disclosed is a method of producing a layered device.

